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FAIRCHILD

SEMICONDUCTOR TM

FDV301N Digital FET , N-Channel

General Description

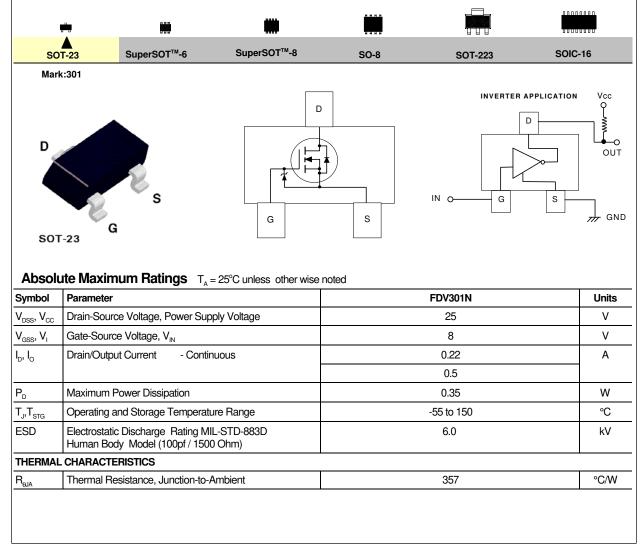
This N-Channel logic level enhancement mode field effect transistor is produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance. This device has been designed especially for low voltage applications as a replacement for digital transistors. Since bias resistors are not required, this one N-channel FET can replace several different digital transistors, with different bias resistor values.

Features

- 25 V, 0.22 A continuous, 0.5 A Peak. $R_{DS(ON)} = 5 \Omega @ V_{GS} = 2.7 V$ $R_{DS(ON)} = 4 \Omega @ V_{GS} = 4.5 V.$
- Very low level gate drive requirements allowing direct operation in 3V circuits. V_{GS(th)} < 1.06V.

June 2009

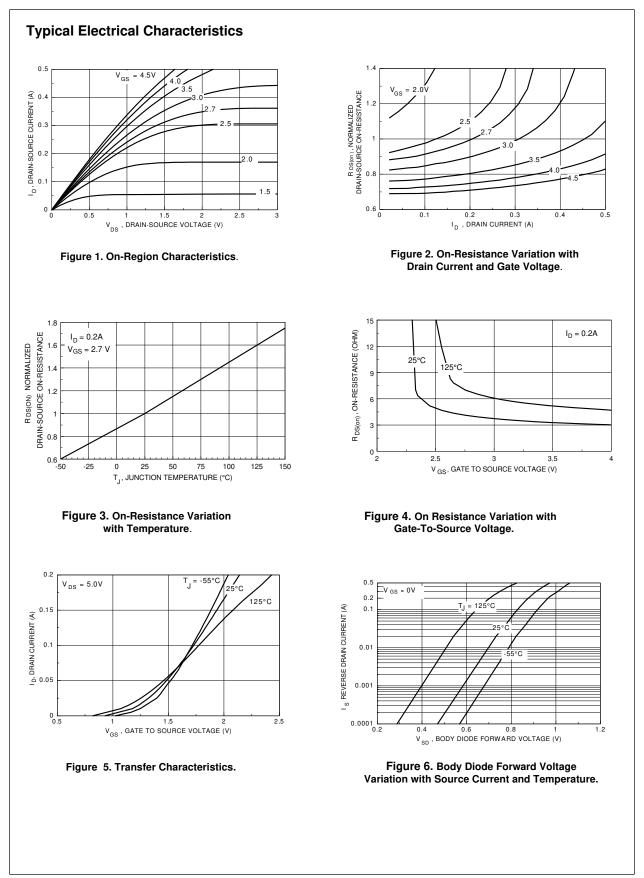
- Gate-Source Zener for ESD ruggedness.
 >6kV Human Body Model
- Replace multiple NPN digital transistors with one DMOS FET.

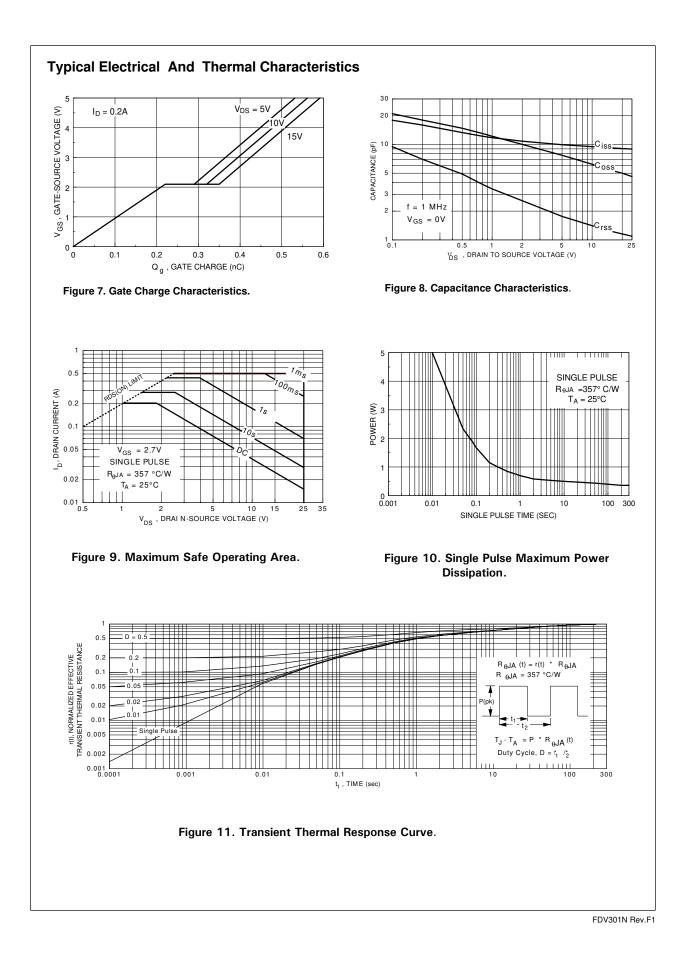


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Symbol	Parameter	Conditions		Min	Тур	Max	Units
O (off)	Zero Input Voltage Output Current	$V_{CC} = 20 V, V_{I} = 0 V$				1	μA
V _{I (off)}	Input Voltage	$V_{cc} = 5 V, I_{o} = 10 \mu A$				0.5	V
V _{I (on)}		$V_{\odot} = 0.3 \text{ V}, I_{\odot} = 0.005 \text{ A}$		1			V
R _{O (on)}	Output to Ground Resistance	$V_1 = 2.7 \text{ V}, \ I_0 = 0.2 \text{ A}$			4	5	Ω
Electric	al Characteristics (T _A = 25 °C unless	s otherwise noted)					
Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHAP	RACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = 250 \mu A$		25			V
$\Delta BV_{DSS} / \Delta T_{C}$	Breakdown Voltage Temp. Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°	С		25		mV / °C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$				1	μA
		T	= 55°C			10	μA
GSS	Gate - Body Leakage Current	$V_{GS} = 8 V, V_{DS} = 0 V$				100	nA
ON CHARA	CTERISTICS (Note)						
$\Delta V_{GS(th)} / \Delta T_J$	Gate Threshold Voltage Temp. Coefficient	$I_{D} = 250 \ \mu\text{A}$, Referenced to 25°	C		-2.1		mV/°C
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$		0.70	0.85	1.06	V
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = 2.7 \text{ V}, \ I_{D} = 0.2 \text{ A}$			3.8	5	Ω
		T	=125°C		6.3	9	
		$V_{GS} = 4.5 \text{ V}, \ \text{I}_{D} = 0.4 \text{ A}$			3.1	4	
D(ON)	On-State Drain Current	$V_{GS} = 2.7 \text{ V}, V_{DS} = 5 \text{ V}$		0.2			Α
9 _{FS}	Forward Transconductance	$V_{DS} = 5 V, I_{D} = 0.4 A$			0.2		S
DYNAMIC (CHARACTERISTICS						
C _{iss}	Input Capacitance	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1.0 MHz			9.5		pF
C _{oss}	Output Capacitance				6		pF
C _{rss}	Reverse Transfer Capacitance				1.3		pF
SWITCHIN	G CHARACTERISTICS (Note)						
D(on)	Turn - On Delay Time	$V_{DD} = 6 V, I_D = 0.5 A,$			3.2	8	ns
r	Turn - On Rise Time	$V_{GS} = 4.5 \text{ V}, \text{ R}_{GEN} = 50 \Omega$	_		6	15	ns
D(off)	Turn - Off Delay Time		_		3.5	8	ns
f	Turn - Off Fall Time				3.5	8	ns
С ^д	Total Gate Charge	$V_{DS} = 5 V, I_{D} = 0.2 A, V_{GS} = 4.5 V$			0.49	0.7	nC
Q _{gs}	Gate-Source Charge				0.22		nC
Q _{gd}	Gate-Drain Charge				0.07		nC
DRAIN-SO	JRCE DIODE CHARACTERISTICS AND MAXIMU		1				r
S	Maximum Continuous Drain-Source Diode Fo	s Drain-Source Diode Forward Current				0.29	Α
V _{SD}	Drain-Source Diode Forward Voltage	$V_{\rm GS} = 0 \ V, \ I_{\rm S} = 0.29 \ A$ (Note)			0.8	1.2	V

Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2.0%.







SEMICONDUCTOR

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G <i>max</i> ™	Quiet Series™	TinyBuck™
GTO™	RapidConfigure™	TinyLogic [®]
IntelliMAX™	\sim	TINYOPTO™
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